# 2048-BIT(128-WORD BY 16-BIT) ELECTRICALLY ERASABLE AND PROGRAMMABLE ROM

#### DESCRIPTION

The M6M80021P, L, FP are 2048-bit (128-word x 16-bit) electrically erasable CMOS EEPROMs, and all have a built-in high voltage generator to enable operation in all modes by a single 5V power supply.

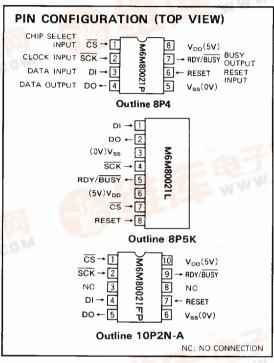
The difference between M6M80021P, M6M80021L and M6M80021FP is only outline of package, and the following explanations are for M6M80021P unless specifically indicated otherwise.

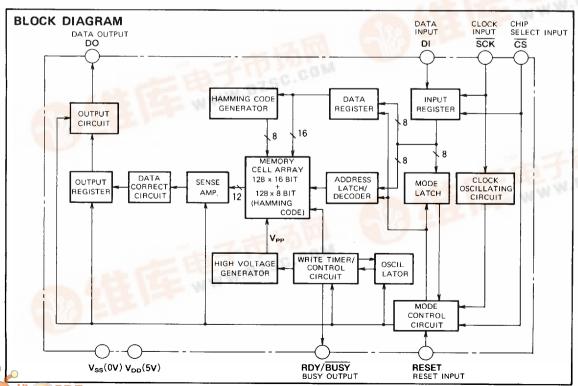
#### **FEATURES**

- Single 5V power supply
- Clock synchronous serial I/O
- Three ports control (CS and RESET, DI and DO can be interconnected.)
- Buit-in sequential controller
- 100000 erase/write cycles
- 10 years data retention

#### **APPLICATION**

M6M80021 is especially suitable for use as a nonvolatile channel memory for electronic tuner and as the read only memory system that must be frequently reprogrammed in the field.





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#### **FUNCTIONS**

M6M80021P is a clocked serial port compatible EEPROM, and data is input from the rising edge of clock signal and output by synchronizing to the falling edge of clock signal.

Data is grouped by 8 bits. The beginning 8 bits specify the mode, next 8 bits specify the address, and subsequent 16 bits specify the I/O data.

Any of five modes (write, read, write enable, write disable, status output) may be specified. The write time is set by an internal timer, and determination of whether write operation is in progress or not can be made from status of the RDY/BUSY pin or the DO pin status after the status mode has been set.

### PIN DESCRIPTION

Pin	Name	Functions
CS	Chip select input	<ul> <li>① Chip selection is made by setting this pin to "L". When this port is "H", the internal sequential controller is reset. Therefore, this pin must be set to "H" before executing each mode.</li> <li>② During the write operation (when BUSY output is "L"), write operation is continued regardless of the input to this pin.</li> <li>③ After write operation is finished, this pin must be set to "H" to make mode reading possible. In the case of "status output" mode only, reading is possible even if this pin is "L" after the sequential controller has been reset and t<sub>STA</sub> has elapsed since the time when the write operation was started.</li> </ul>
SCK	Clock input	Input data is read at the rising edge of clock.     Data is output by synchronizing to the falling edge of clock.
DI .	Data input	Data is input from this pin.
DO	Data output	Data is output from this pin, DI and DO can be interconnected.
RESET	Reset input	Must be set to "H" at the time of power ON or OFF.     When this pin is set to "H", the sequential controller and the write circuit are reset for memory protection. If this pin becomes "H" during write operation, the operation is halted.     This pin and CS can be interconnected. When this is done, CS (=RESET) must be held to "L" during write operation.
RDY/BUSY	Busy output	This is "L" during write operation.     This is "L" at the time of power ON or OFF. In this condition, all inputs are disabled.

#### MODE FUNCTIONS

Name         Mode           Read         10101000		Address	Data	Functions	
		A <sub>0</sub> A <sub>1</sub> A <sub>2</sub> A <sub>3</sub> A <sub>4</sub> A <sub>5</sub> A <sub>6</sub> 0	$D_0 \sim D_7 D_8 \sim D_{15}$	Read from addresses < A₀~A₆;	
Write	10100100	A <sub>0</sub> A <sub>1</sub> A <sub>2</sub> À <sub>3</sub> A <sub>4</sub> A <sub>5</sub> A <sub>6</sub> 0	$D_0 \sim D_7 D_8 \sim D_{15}$	Write into addresses <a₀∼a₀></a₀∼a₀>	
Write enable	10100011	xxxxxxx		Write operation is enabled.	
Write disable	10100000	xxxxxxx		Write operation is disabled.	
			(Busy)	Busy flag	
		00xxxxxx	1 (Ready)		
0		10xxxxxx	0 (Enable)	Mission annulus files	
Status output	10101001		1 (Disable)	Write enable flag	
		01	0 (Correct)	FCC 41	
		01XXXXXX	1 (Incorrect)	ECC flag	



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#### STATUS OUTPUT MODE

#### (1) Busy flag

The busy flag serves the same function as the  $\overline{\text{BUSY}}$  output pin.

When this flag is specified, "1" is output when ready from the 16 clock falling edge and "0" is output if busy (write operation in progress).

#### (2) Write enable flag

M6M80021P has a write enable flag, and write operation is executed only when this flag is "0". The contents of this flag can be updated only in the write enable (WEN) mode and the write disable (WDS) mode. The contents of this flag is underfined at the power on time, so that the WEN mode must be set before setting the write mode for write operation.

Once the WEN mode is set and this flag is set to the enable state, latch is in effect until the WDS mode is set. EEPROM can be read regardless of the status of this flag.

#### (3) ECC flag

An ECC circuit, which corrects data errors, is built-in to insure high degree of memory cell reliability. The ECC circuit corrects data errors and outputs the corrected error if there is only one error each in the high-order 8 bits and the low-order 8 bits of 1 word (16 bits). When an error is corrected in at least one of the high-order or low-order byte, this flag is set to "1" to indicate that error correction has been made. The data is corrected in this case. When this flag is "0", it indicates that the correct data value was output without having to active the ECC circuit. By setting the ECC mode after the read mode, ECC information on the address that was specified immediately before can be varified.

### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Test conditions	Ratings	Unit
V <sub>DD</sub>	Supply voltage		-0.3~6.0	v
Vi	Input voltage		-0.3~V <sub>DD</sub> +0.3	V
Vo	Output voltage		-0.3~V <sub>DD</sub> +0.3	V
l <sub>oн</sub>	High-level output current		0~10	mA
loL	Low-level autput current		0~10	mA
T <sub>stg</sub>	Storage temperature		<b>−40~125</b>	ొ
Topr	Operating temperature		-10~70	

#### RECOMMENDED OPERATING CONDITIONS (Ta=-10~70°C, VDD=5V±10%, unless otherwise noted)

Symbol	Parameter		Limits			
	rarameter .		Nom	Max	Unit	
V <sub>DD</sub>	Supply voltage	4.5	5. 0	5. 5	٧	
V <sub>IH</sub>	High-level input voltage DI	0.7V <sub>DD</sub>	V <sub>DD</sub>	VDD	٧	
V <sub>IH</sub>	High-level input voltage RESET, CS, SCK	0.8V <sub>DD</sub>	V <sub>DD</sub>	V <sub>DD</sub>	٧	
VIL	Low-level input voltage DI	0	0	0.3V <sub>DD</sub>	٧	
VIL	Low-level input voltage RESET, CS, SCK	0	0	0. 2V <sub>DD</sub>	٧	

### DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test conditions		Limits			
	1 at at tietes		Min	Тур	Max	Unit	
V <sub>DD</sub>	Supply voltage		4.5	5.0	5, 5	V	
IDD	Supply current	V <sub>DD</sub> =5.5V		5	8	mA	
ViH	High-level input voltage DI		0.7V <sub>DD</sub>		V <sub>DD</sub>	V	
VIH	High-level input voltage RESET, CS, SCK		0.8V <sub>DD</sub>		V <sub>DD</sub>	v	
VIL	Low-level input voltage DI		0		0.3V <sub>DD</sub>	V	
VIL	Low-level input voltage RESET, CS, SCK		0		0.2V <sub>DD</sub>	V	
V <sub>OH</sub>	High-level output voltage	I <sub>OH</sub> =-400 μA	2.4			V	
VoL	Low-level output voltage	I <sub>OL</sub> =2.1mA			0.4	V	

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### AC ELECTRICAL CHARACTERISTICS

	Parameter	Test conditions	Limits			Unit
Symbol			Min	Тур	Max	Unit
twH	Positive data shift clock pulse width		450			ns
t <sub>WL</sub>	Negative clock pulse width		450			ns
twwн	Clock hold time (every 8 clocks)		4			μS
tsu(cs-sck)	Chip select set up time before the fall of the clock		1			μ\$
th(sck-cs)	Chip select hold time after the rise of the clock		4			μS
tsu(DI-SCK)	Data set up time before the rise of the clock		150			ns
th(SCK-DI)	Data hold time after the rise of the clock		200			ns
tsu(sck-cs)	Clock set up time before the fall of the chip select		1			μS
th(cs-sck)	Clock hold time after the rise of the chip select		1			μS
t <sub>PD</sub>	Data delay time after the fall of the clock				350	ns
tdv	Data valid time after the rise of the chip select				. 1	μS
t <sub>E/W</sub>	Self-time write sequence time				15	ms
t <sub>CSH</sub>	Positive chip select width .		4			μ8
thw	Chip select, clock hold time after the start of the write sequence		4			μS
t <sub>STA</sub> (Note 1)	At setting status mode, clock hold time start of the write sequence when CS is 0.		12			μS

Note 1. t<sub>STA</sub> indicates the maximum value of the sequential controller reset pulse that is generated after the write operation is started. When the sequential controller is reset, only the status output can be read.

### **NONVOLATILE CHARACTERISTICS**

Symbol	Parameter	Test conditions	Limits			4
			Min	Тур	Max	Units
New	Erase/Write cycle per word		105			cycles
t <sub>s</sub>	Data retention	N <sub>EW</sub> == 105	10			years

### 2048-BIT(128-WORD BY 16-BIT) ELECTRICALLY ERASABLE AND PROGRAMMABLE ROM

#### **TIMING DIAGRAMS**

### (1) Synchronizing data I/O timing

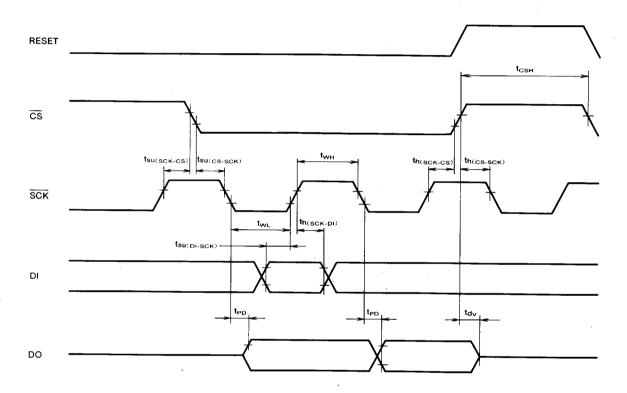


Fig. 1 Synchronizing timing

### (2) SCK "H" hold time at every 8 clocks

The timing pattern shown above is maintained during transfer of 8-bit data, but the clock "H" hold time  $t_{wwh}$  is necessary at every 8th clock for  $\overline{SCK}$  input in all modes.

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### **TIMING CHART for VARIOUS MODES**

## (1) When controlling CS and RESET pins

## • Write enable and write disable mode

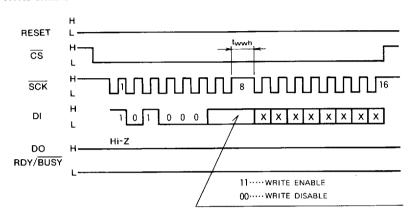


Fig. 2 Sequence at write enable and write disable modes

#### Status output mode

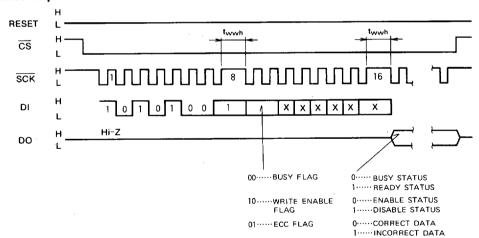


Fig. 3 Sequence at status output mode

The status of each status flag specified from the DO pin is output starting at the rising edge of the 16th clock. Output is not dependent on clock but continues until  $\overline{\text{CS}}$  becomes "H".

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#### Read mode

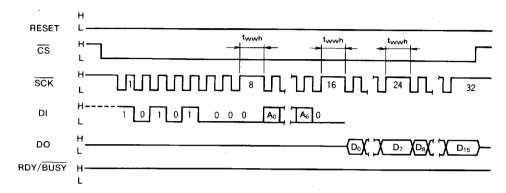


Fig. 4 Sequence at read mode

#### Write mode

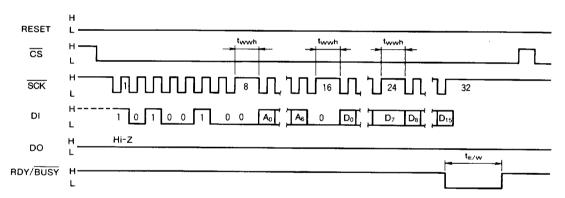


Fig. 5 Sequence at write mode

Execution of the write operation starts at the rising edge of the 32nd clock,

During the write operation, the  $\overline{CS}$  input value may be either "H" or "L". If the  $\overline{CS}$  pin is held to "L" during the write operation, the read operation is possible only in the status mode.

Thus, the SCK is to be used for other tasks during the

write operation,  $\overline{CS}$  should be set to "H" as shown in Figure 6 (even is  $\overline{CS}$  is held to "L",  $\overline{SCK}$  can be used by other tasks if a dummy bit input is performed as shown in Figure 10).

To read next mode after  $t_{\text{E/W}}$ ,  $\overline{\text{CS}}$  must be set to "H" first.



# M6M80021P.L.FP

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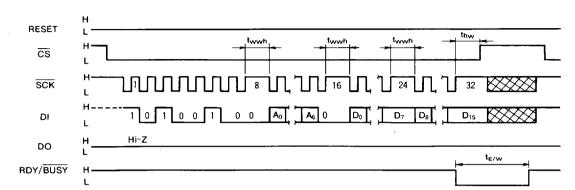


Fig. 6 Sequence at write mode

To use  $\overline{SCK}$  and DI for other tasks during the write operation,  $\overline{CS}$  must be set to "H" after  $t_{hw}$  has elapsed from the rising edge of the 32nd clock as shown in Figure 6.

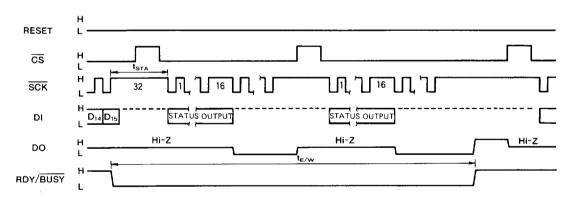


Fig. 7 Sequence of status output (busy flag) during the write operation

After write operation has started, the sequential controller is reset automatically, so read operation in the status mode become possible only after  $t_{STA}$  has elapsed from the time the write operation started without having to set  $\overline{\text{CS}}$  to "H".

Before the status mode is set again,  $\overline{\text{CS}}$  must be set to "H" as in the ordinary mode setting procedure.



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# (2) When connecting between CS and RESET pins

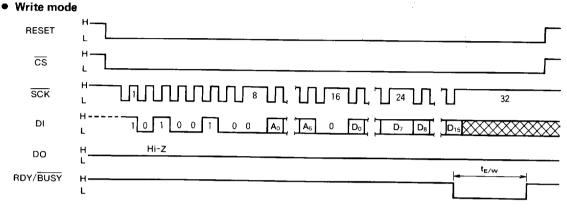


Fig. 8 Sequence of write operation

During the write operation, the  $\overline{\text{CS}}=\text{RESET}$  pin must be set to "L".

Because the read operation is possible only in the status mode once the write operation starts as described above,  $\overline{SCK}$  must be held to "H" when not setting the status mode. For using  $\overline{SCK}$  and DI for other tasks during the write operation, see Figure. 10.

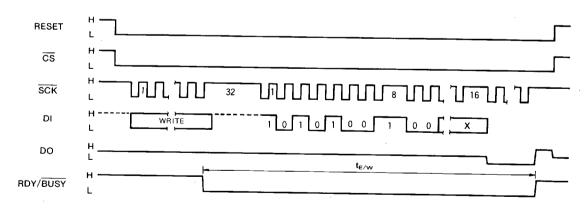


Fig. 9 Sequence of status output during write operation

The read operation in the status mode becomes possible after  $t_{STA}$  has elapsed from the time the write operation started. Attention is called to the fact, when the status mode is set, the DO pin is in the output state until  $\overline{CS}$  is set to "H".



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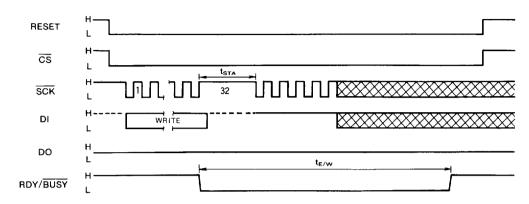


Fig. 10 Sequence of write operation

As shown in Figure 9, the read operation in the status mode becomes possible after  $t_{STA}$  has elapsed from the time the write operation started, and the DO pin is set to the output state when the status mode is set. When using the DO pin is addition to the  $\overline{SCK}$  and DI pins for other tasks, a dummy bit input must be made after  $t_{STA}$  has elapsed from the time the write operation started to avoid the status mode before executing the other tasks.

Other (than dummy bit) data input is equally effective for this purpose as long as it does not generate the status mode instruction code (10101001).

